



flowPIM E1

600 V / 30 A

Features

- Trench Fieldstop IGBT3 technology
- Standard industrial housing
- Optimized $R_{th(j-s)}$ with Phase Change Material
- Built-in NTC

Target applications

- Industrial Drives

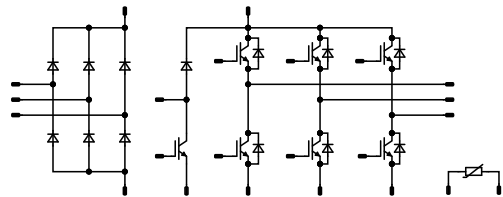
Types

- 10-E106PMA030SA-L926A38Z

flow E1 12 mm housing



Schematic





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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	36	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	73	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 360\text{ V}$ $T_j = 150\text{ °C}$	6	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	36	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	58	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Brake Switch

Collector-emitter voltage	V_{CES}		600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	36	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	90	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	73	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 360\text{ V}$ $T_j = 150\text{ °C}$	6	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Brake Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	19	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	41	W
Maximum junction temperature	T_{jmax}		175	°C

Rectifier Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	47	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	270	A
Surge current capability	I^2t		370	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	61	W
Maximum junction temperature	T_{jmax}		150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			>12,7	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	I_F [A]	T_j [°C]	Min	Typ	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00043	25	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 150	1,1	1,57 1,8	1,9 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	600		25			1,6	μA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							1630		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		108		pF
Reverse transfer capacitance	C_{res}							50		pF

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,29		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 16$ Ω $R_{goff} = 16$ Ω	±15	300	30	25		106		ns
Rise time	t_r					150		103,8		
						25		14,4		ns
Turn-off delay time	$t_{d(off)}$					150		19,6		
						25		145,8		ns
Fall time	t_f					150		170,8		
		25		92,37		ns				
Turn-on energy (per pulse)	E_{on}	$Q_{trFD} = 1,34$ μC				25		0,475		mWs
		$Q_{trFD} = 2,65$ μC				150		0,665		
Turn-off energy (per pulse)	E_{off}					25		0,675		mWs
						150		0,913		



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Diode

Static

Forward voltage	V_F				30	25 150	1,25	1,64 1,55	1,95 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 600$ V				25			27	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,63		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=2285$ A/μs $di/dt=1902$ A/μs	±15	300	30	25		27,01		A
Reverse recovery time	t_{rr}					150		33,86		
						25		146,13		
Recovered charge	Q_r					150		253,4		
						25		1,34		
Reverse recovered energy	E_{rec}					150		2,65		
		25		0,29						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	150		0,568	mWs					
		25		1752						
						150		815,19		A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Brake Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00043	25	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	25 150	1,1	1,57 1,8	1,9 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	600		25			1,6	μA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							1630		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		108		pF
Reverse transfer capacitance	C_{res}							50		pF

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,29		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		49 46,4 45,6		ns
Rise time	t_r					25 125 150		46,8 49,2 50		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		554 569,2 587,8		ns
Fall time	t_f					25 125 150		26,84 29,11 28,47		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,704$ μC $Q_{tFWD} = 1,28$ μC $Q_{tFWD} = 1,48$ μC				25 125 150		1,52 1,86 1,92		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		1,26 1,47 1,52		mWs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Brake Diode

Static

Forward voltage	V_F				10	25 150	1,25	1,61 1,56	1,95 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 600$ V				25			27	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,33		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=559$ A/μs $di/dt=513$ A/μs $di/dt=456$ A/μs	0/15	400	30	25		6,44		A
Reverse recovery time	t_{rr}					125		7,76		
						150		8,24		
						25		275,29		
Recovered charge	Q_r					125		370,99		
						150		408,63		
		25		0,704						
Reverse recovered energy	E_{rec}	125		1,28						
		150		1,48						
		25		0,17						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	125		0,308						
		150		0,364						
		25		838,81						
						125		14,34		A/μs
						150		13,62		



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_{CE} [V]	T_j [°C]	Min	Typ	Max	

Rectifier Diode

Static

Forward voltage	V_F				28	25 125		1,15 1,11	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 1600$ V				25 150			100 1000	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,15		K/W
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Thermistor

Static

Rated resistance	R					25		5		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 493$ Ω				100	-5		5	%
Power dissipation	P							245		mW
Power dissipation constant	d					25		1,4		mW/K
B-value	$B_{(25/50)}$	Tol. ±2 %						3375		K
B-value	$B_{(25/100)}$	Tol. ±2 %						3437		K
Vincotech Thermistor Reference									K	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

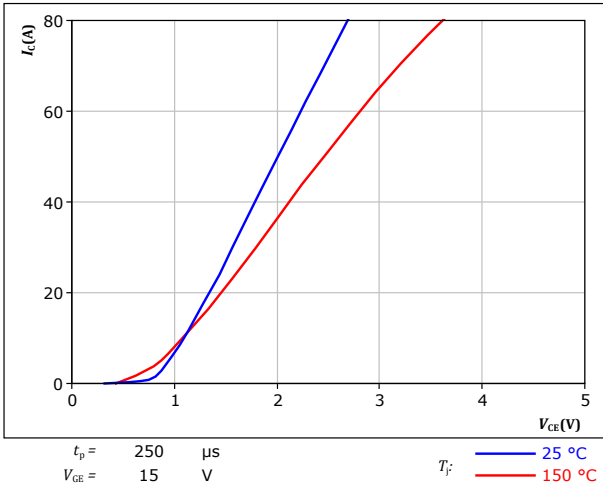


figure 2. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

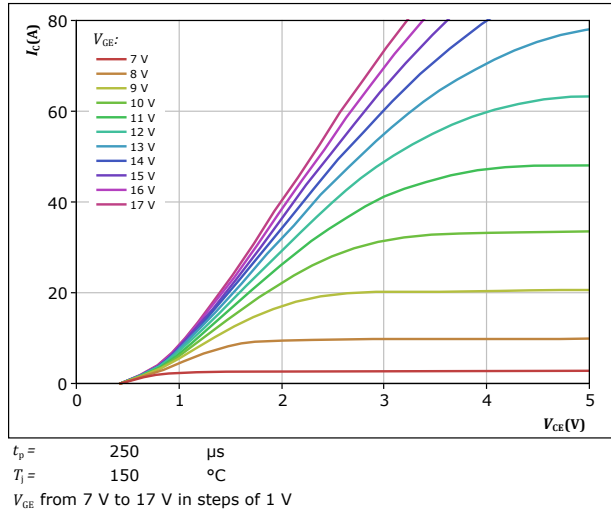


figure 3. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

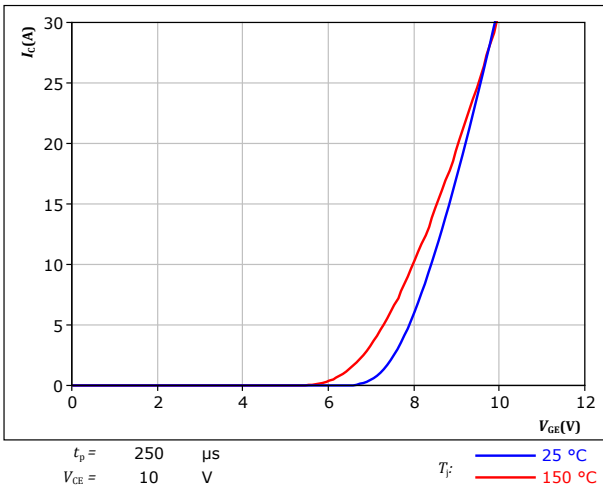
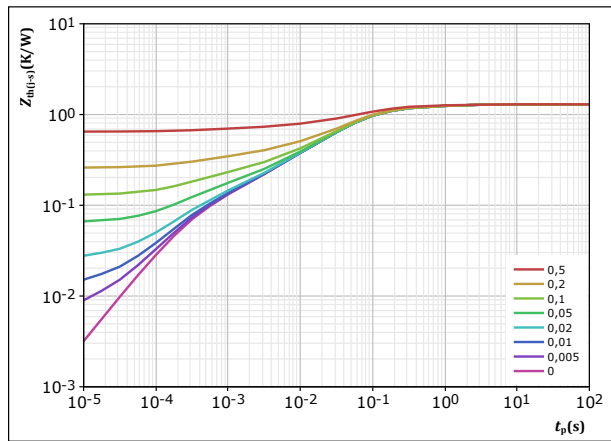


figure 4. IGBT

Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



$D = t_p / T$
 $R_{th(j-s)} = 1,295 \text{ K/W}$
 IGBT thermal model values

R (K/W)	τ (s)
8,66E-02	1,69E+00
1,77E-01	2,34E-01
7,04E-01	5,82E-02
1,82E-01	1,03E-02
6,93E-02	1,92E-03
7,70E-02	3,01E-04



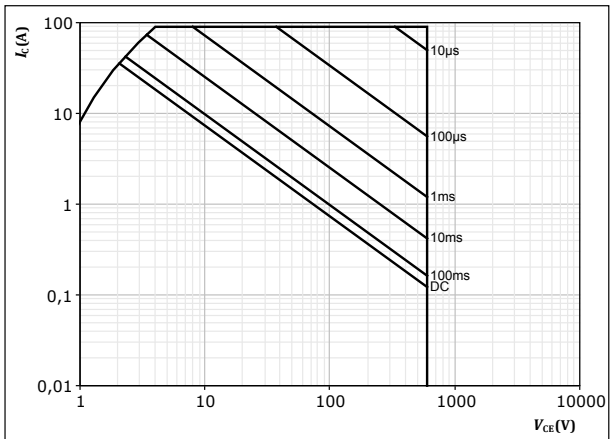
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Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{CE} = 15$ V

$T_j = T_{jmax}$

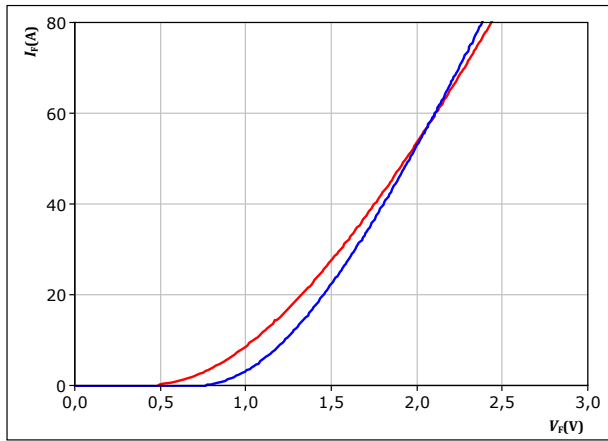


Inverter Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

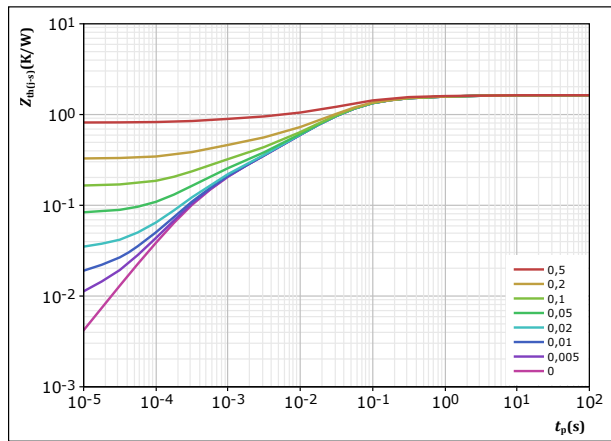


$t_p = 250 \mu s$
 $T_j: 25 \text{ }^\circ\text{C}$ (blue line), $150 \text{ }^\circ\text{C}$ (red line)

figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,633 \text{ K/W}$
FWD thermal model values

R (K/W)	τ (s)
$7,13E-02$	$2,70E+00$
$1,55E-01$	$3,01E-01$
$7,25E-01$	$5,48E-02$
$3,93E-01$	$1,54E-02$
$1,57E-01$	$2,76E-03$
$1,32E-01$	$4,03E-04$

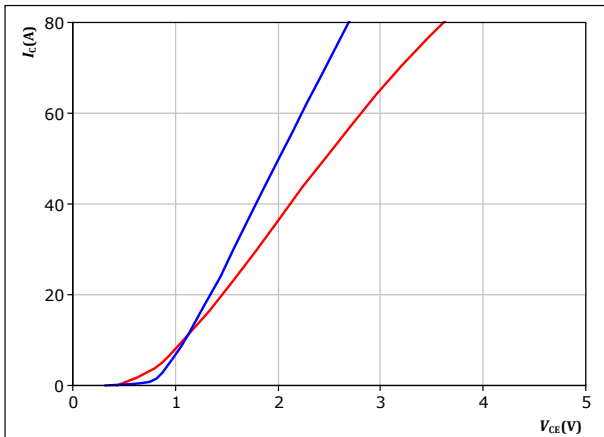


Brake Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

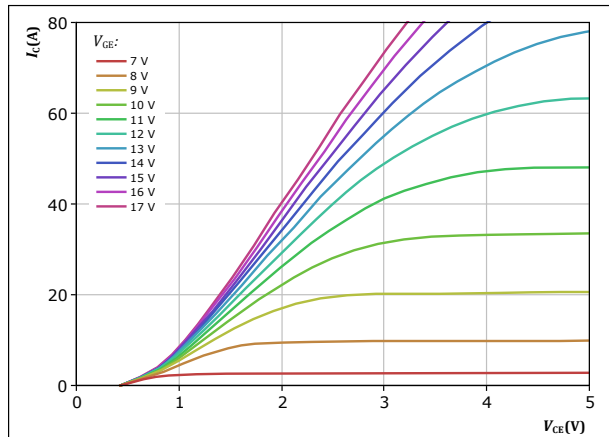


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25^\circ C$ (blue), $150^\circ C$ (red)

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

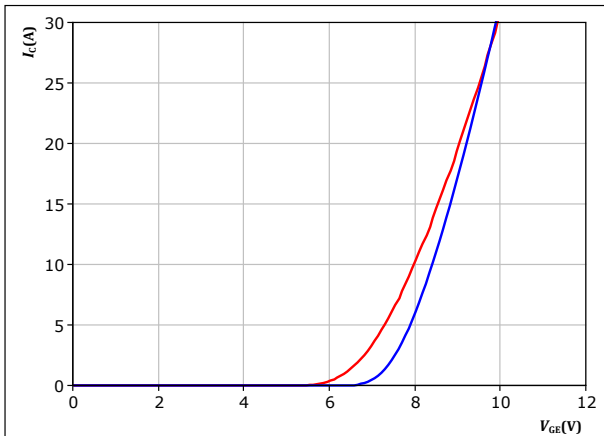


$t_p = 250 \mu s$
 $T_j = 150^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

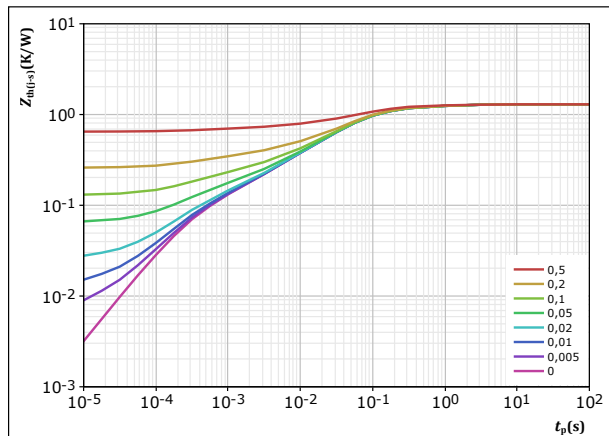


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25^\circ C$ (blue), $150^\circ C$ (red)

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,295 K/W$
IGBT thermal model values

R (K/W)	τ (s)
8,66E-02	1,69E+00
1,77E-01	2,34E-01
7,04E-01	5,82E-02
1,82E-01	1,03E-02
6,93E-02	1,92E-03
7,70E-02	3,01E-04



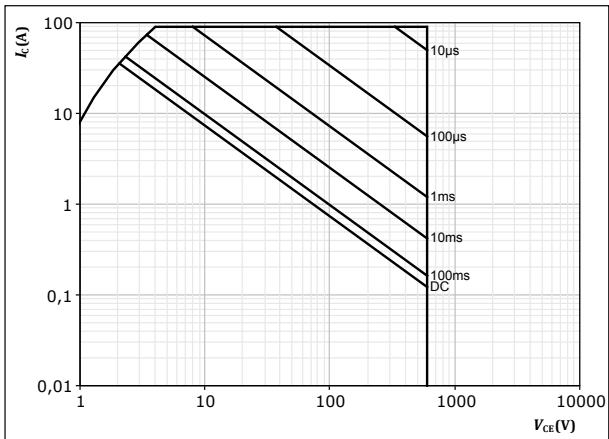
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Brake Switch Characteristics

figure 12. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{CE} = 15$ V

$T_j = T_{jmax}$



Brake Diode Characteristics

figure 13. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

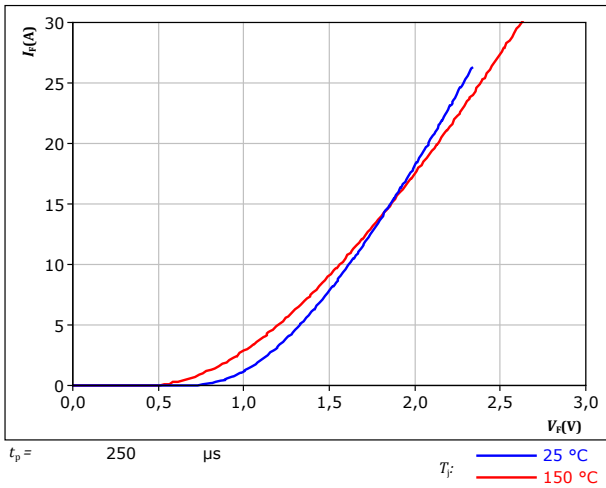
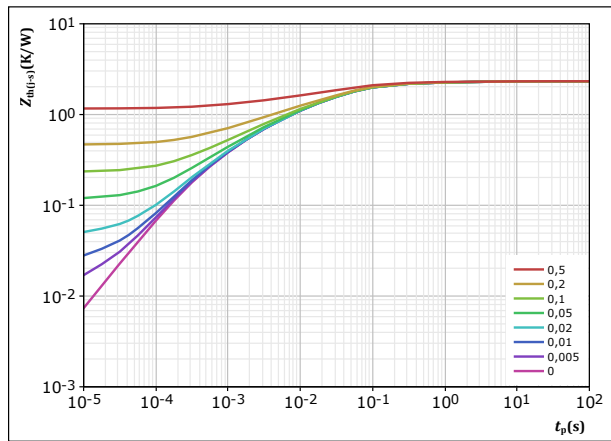


figure 14. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 2,328 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
8,21E-02	3,78E+00
2,22E-01	2,71E-01
9,31E-01	4,55E-02
5,61E-01	8,74E-03
3,70E-01	1,93E-03
1,62E-01	3,48E-04



Rectifier Diode Characteristics

figure 15. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

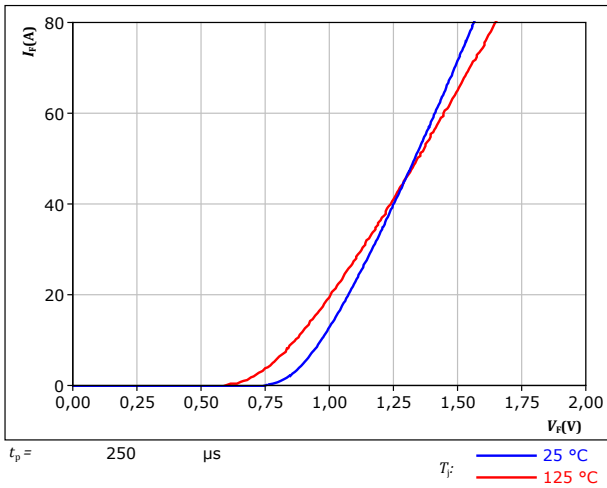
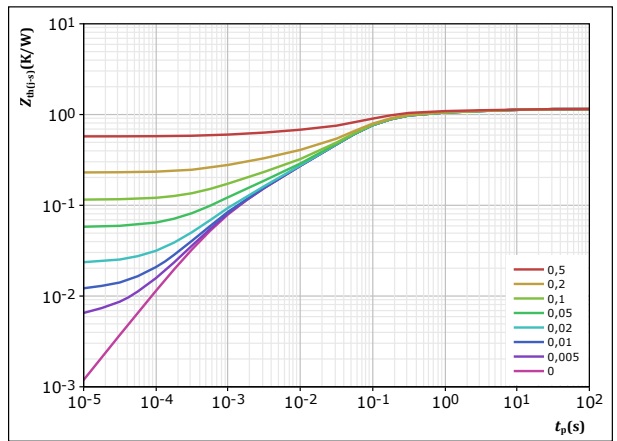


figure 16. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 1,149 \text{ K/W}$

Rectifier thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
8,29E-02	7,59E+00
1,02E-01	6,72E-01
4,20E-01	1,19E-01
3,78E-01	4,22E-02
1,08E-01	4,04E-03
5,78E-02	7,21E-04

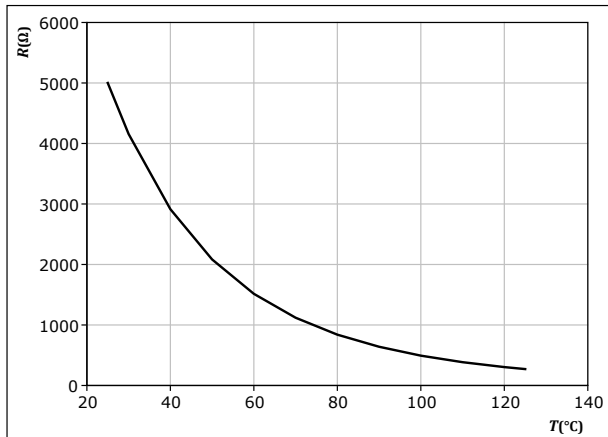


Thermistor Characteristics

figure 17. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

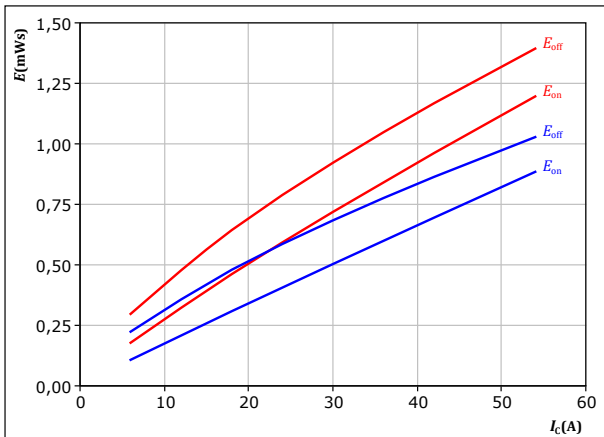




Inverter Switching Characteristics

figure 18. IGBT

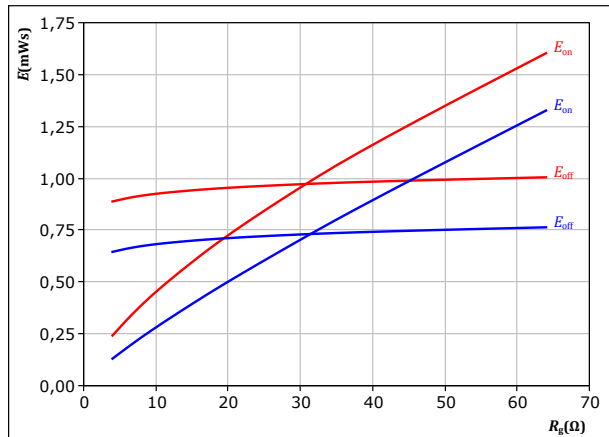
Typical switching energy losses as a function of collector current
 $E = f(I_c)$



With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{g(on)} = 16$ Ω
 $R_{g(off)} = 16$ Ω
 T_j : — 25 °C
— 150 °C

figure 19. IGBT

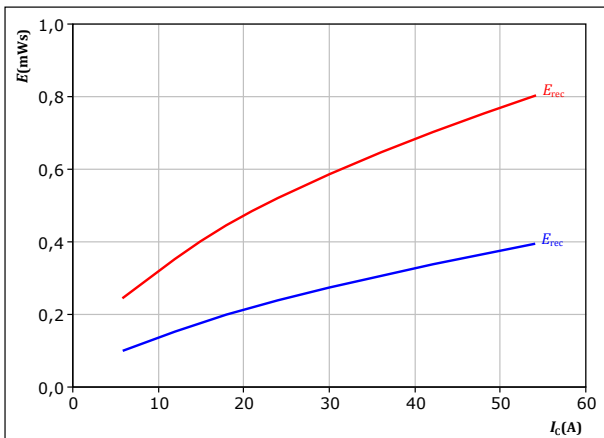
Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$



With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 30$ A
 T_j : — 25 °C
— 150 °C

figure 20. FWD

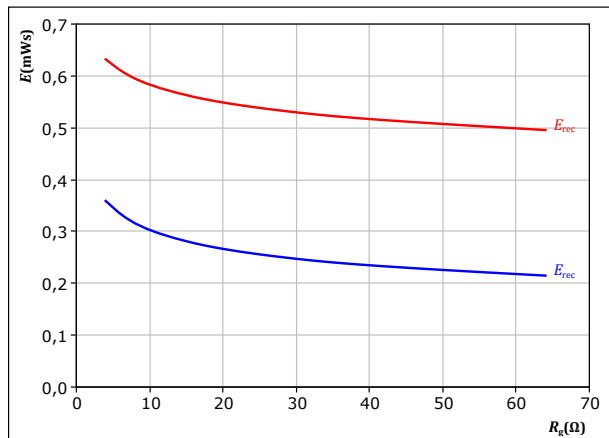
Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$



With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{g(on)} = 16$ Ω
 T_j : — 25 °C
— 150 °C

figure 21. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



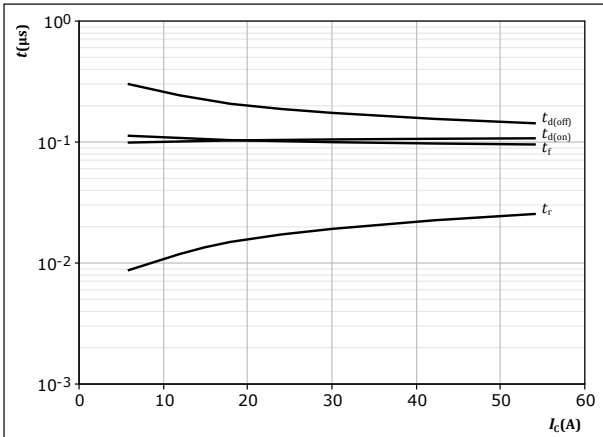
With an inductive load at
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 30$ A
 T_j : — 25 °C
— 150 °C



Inverter Switching Characteristics

figure 22. IGBT

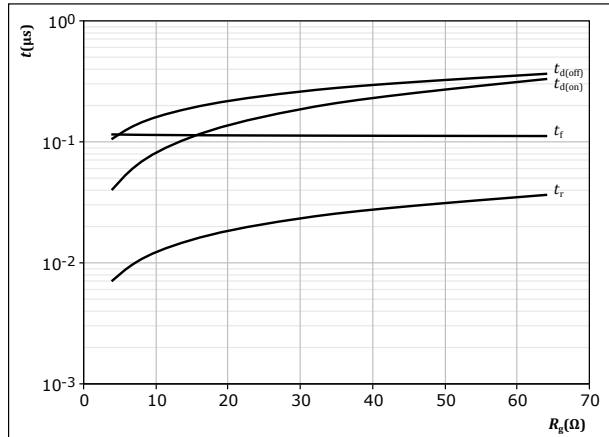
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{g(on)} = 16 \text{ } \Omega$
 $R_{g(off)} = 16 \text{ } \Omega$

figure 23. IGBT

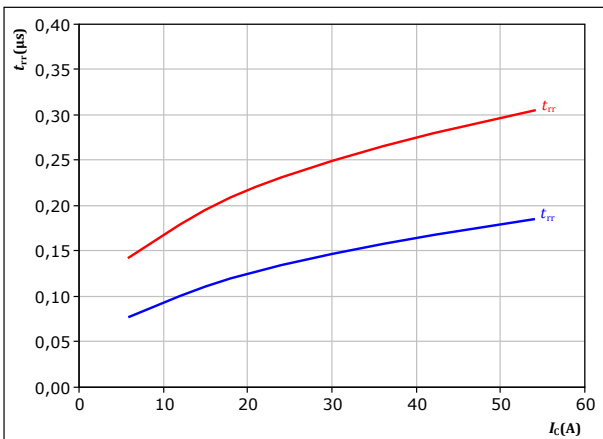
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 30 \text{ A}$

figure 24. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$

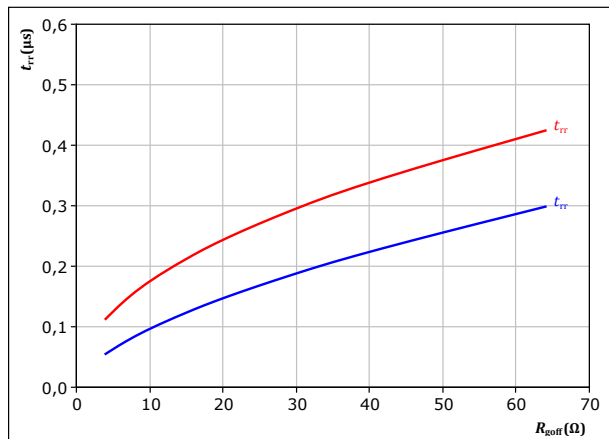


With an inductive load at
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{g(on)} = 16 \text{ } \Omega$

T_j : — 25 °C
 — 150 °C

figure 25. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{g(off)})$



With an inductive load at
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 30 \text{ A}$

T_j : — 25 °C
 — 150 °C

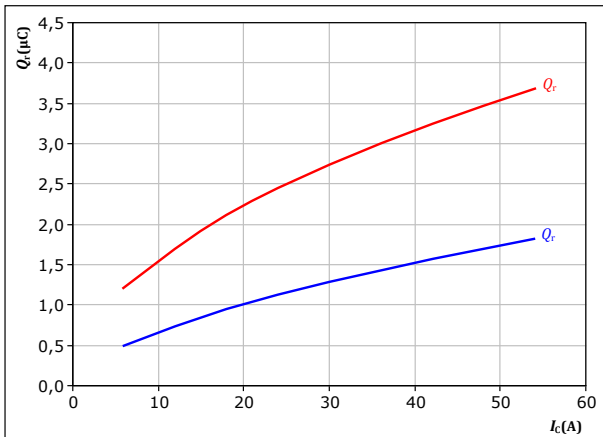


Inverter Switching Characteristics

figure 26. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

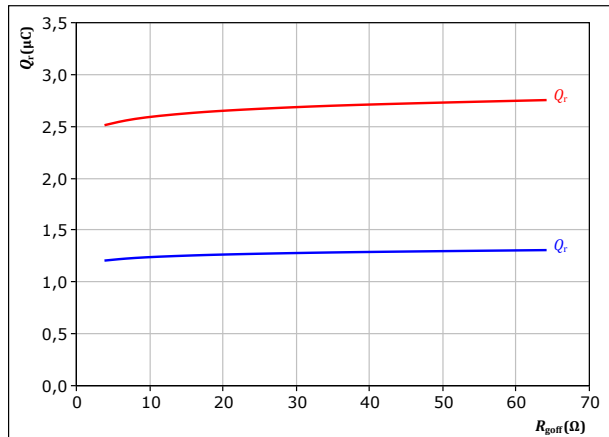
$V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 16$ Ω

T_j : — 25 °C
— 150 °C

figure 27. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

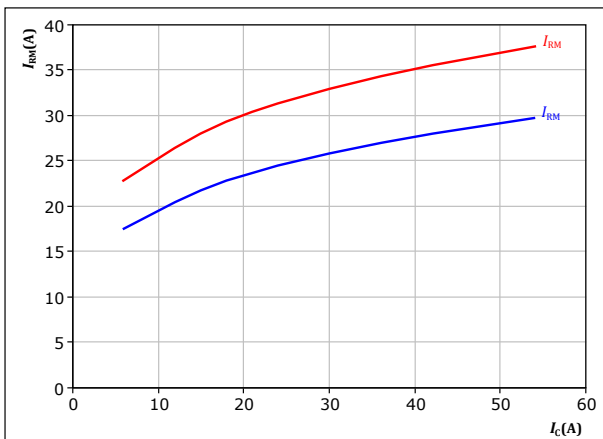
$V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 30$ A

T_j : — 25 °C
— 150 °C

figure 28. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

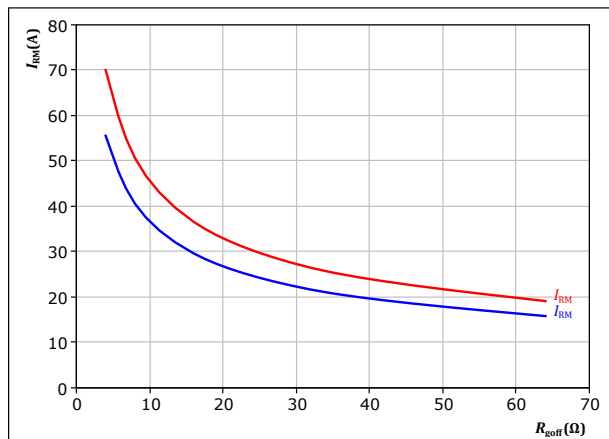
$V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 16$ Ω

T_j : — 25 °C
— 150 °C

figure 29. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 30$ A

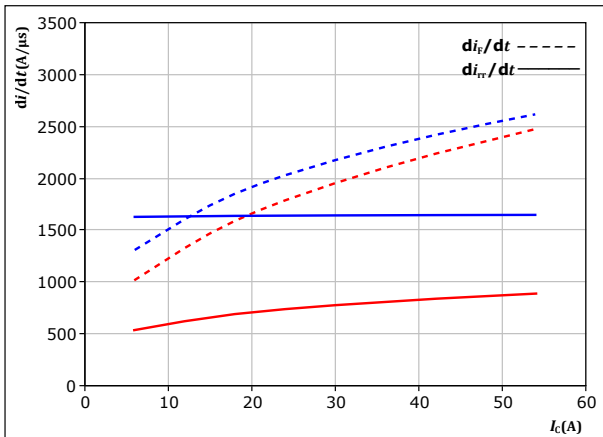
T_j : — 25 °C
— 150 °C



Inverter Switching Characteristics

figure 30. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_c)$

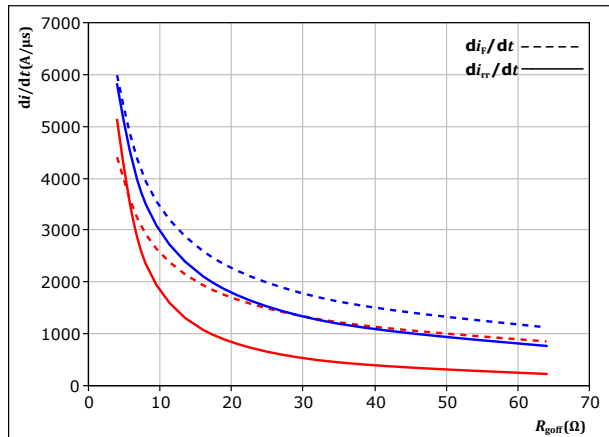


With an inductive load at
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{goff} = 16 \text{ } \Omega$

T_j : — 25 °C
— 150 °C

figure 31. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$

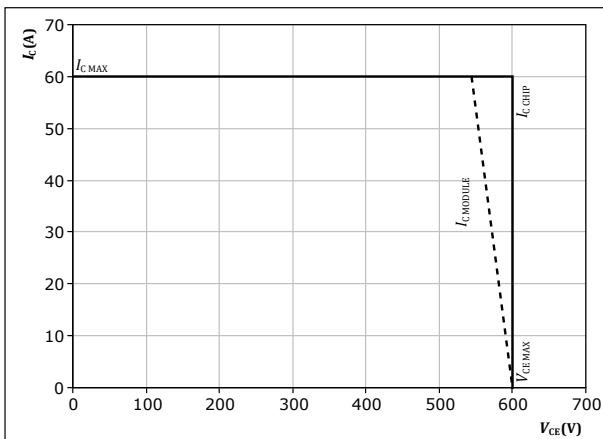


With an inductive load at
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 30 \text{ A}$

T_j : — 25 °C
— 150 °C

figure 32. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



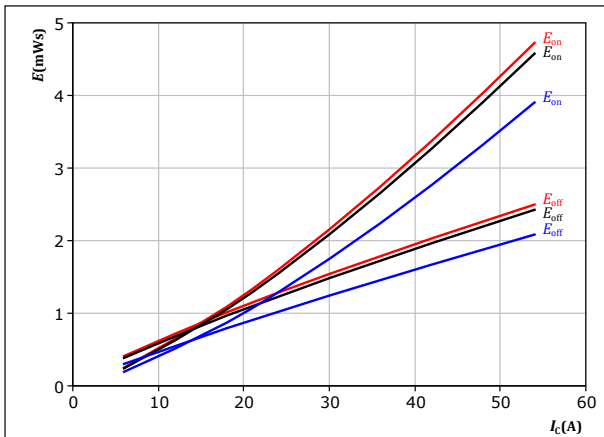
At $T_j = 150 \text{ } ^\circ\text{C}$
 $R_{goff} = 16 \text{ } \Omega$
 $R_{gson} = 16 \text{ } \Omega$



Brake Switching Characteristics

figure 33. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

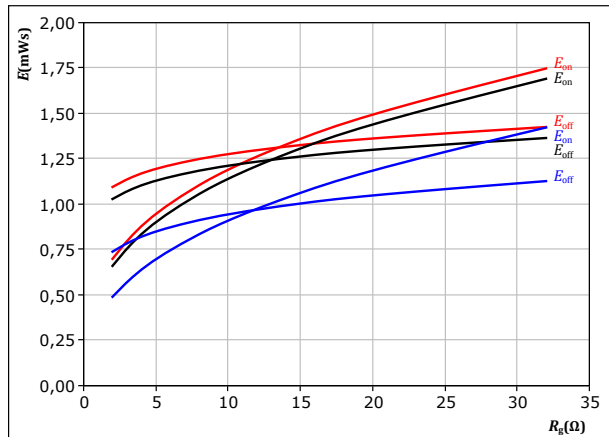


With an inductive load at

$V_{CE} = 400$ V	T_j :	— 25 °C
$V_{GE} = 0/15$ V		— 125 °C
$R_{g(on)} = 32$ Ω		— 150 °C
$R_{g(off)} = 32$ Ω		

figure 34. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

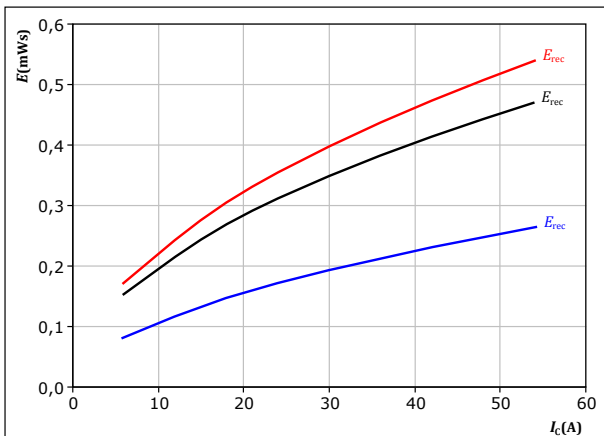


With an inductive load at

$V_{CE} = 400$ V	T_j :	— 25 °C
$V_{GE} = 0/15$ V		— 125 °C
$I_c = 30$ A		— 150 °C

figure 35. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

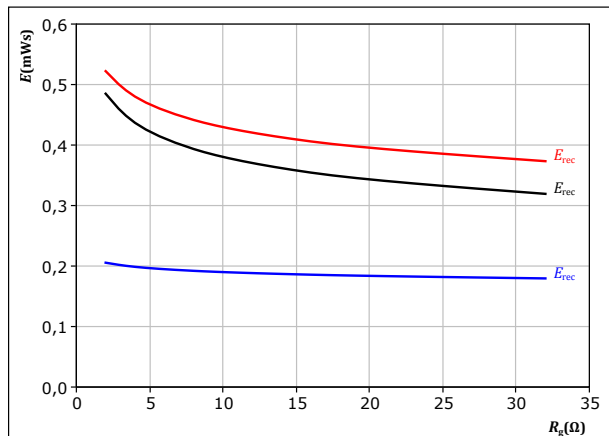


With an inductive load at

$V_{CE} = 400$ V	T_j :	— 25 °C
$V_{GE} = 0/15$ V		— 125 °C
$R_{g(on)} = 32$ Ω		— 150 °C

figure 36. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

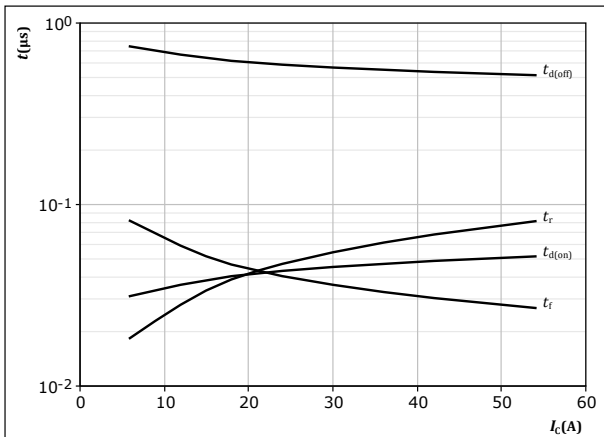
$V_{CE} = 400$ V	T_j :	— 25 °C
$V_{GE} = 0/15$ V		— 125 °C
$I_c = 30$ A		— 150 °C



Brake Switching Characteristics

figure 37. IGBT

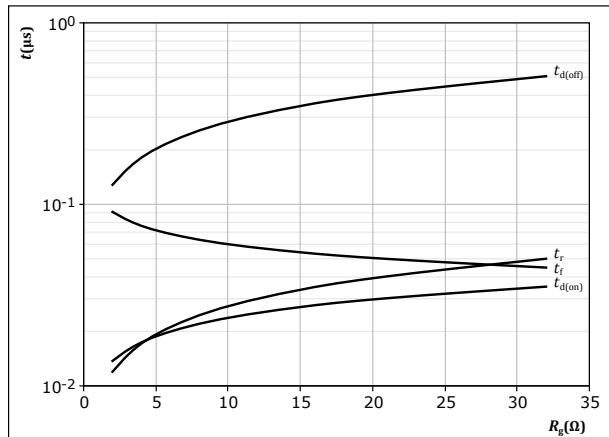
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{g(on)} = 32$ Ω
 $R_{g(off)} = 32$ Ω

figure 38. IGBT

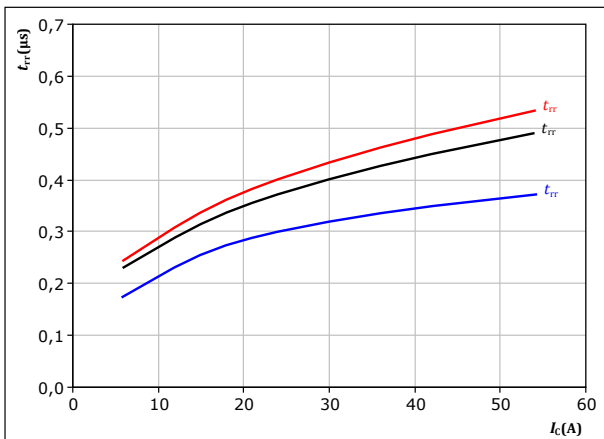
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 30$ A

figure 39. FWD

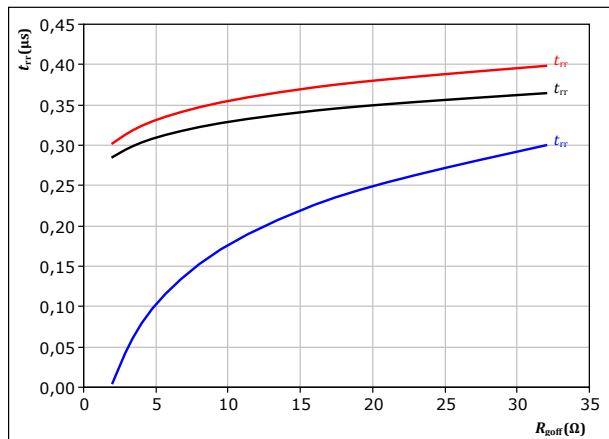
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{g(on)} = 32$ Ω
 T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 40. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{g(off)})$



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 30$ A
 T_j : — 25 °C
 — 125 °C
 — 150 °C

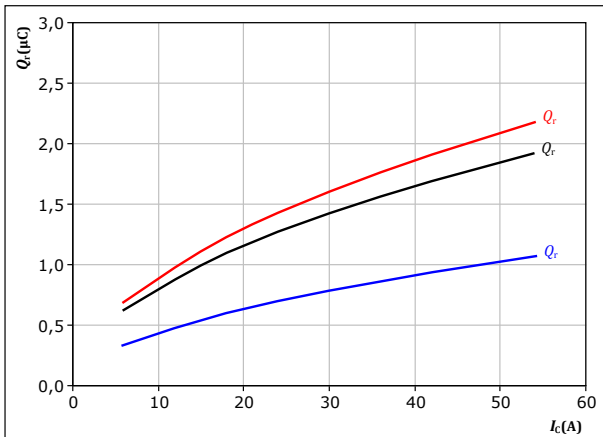


Brake Switching Characteristics

figure 41. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



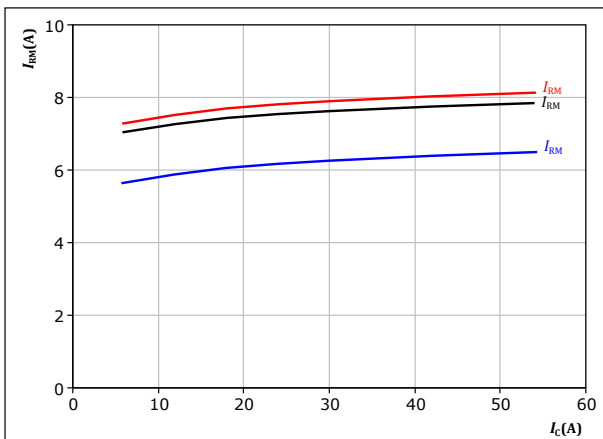
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{goff} = 32$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 43. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



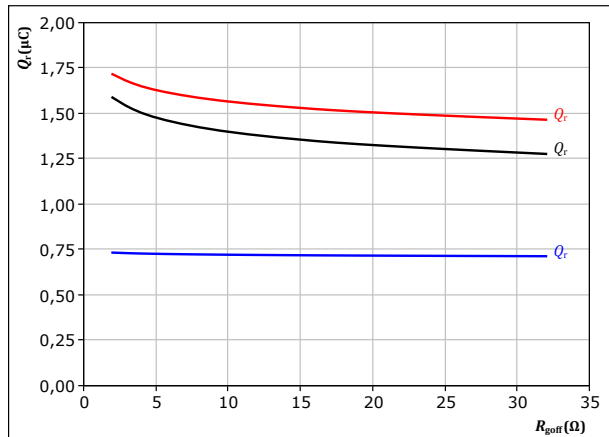
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{goff} = 32$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 42. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



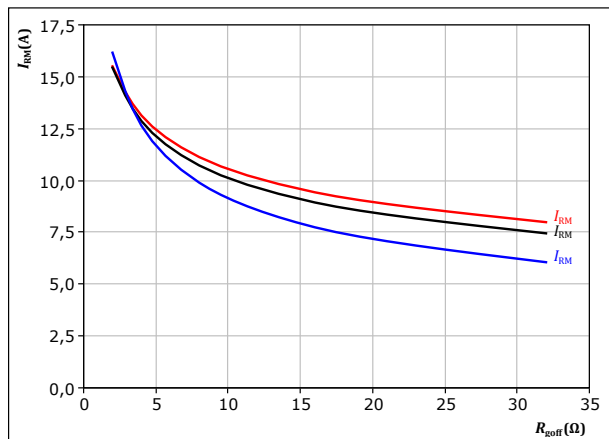
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 30$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 44. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

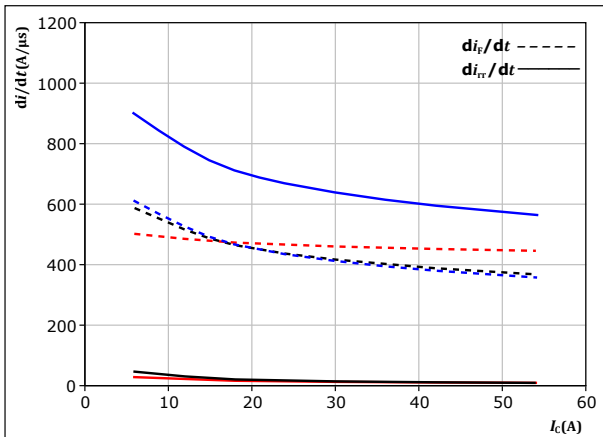
$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 30$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



Brake Switching Characteristics

figure 45. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_i/dt, di_r/dt = f(I_c)$

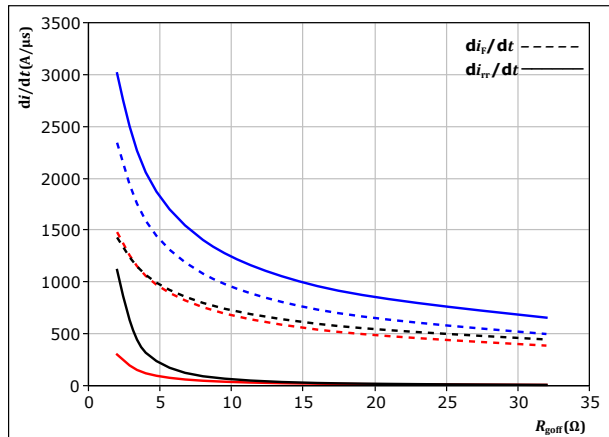


With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 32 \text{ } \Omega$

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 46. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_i/dt, di_r/dt = f(R_{goff})$

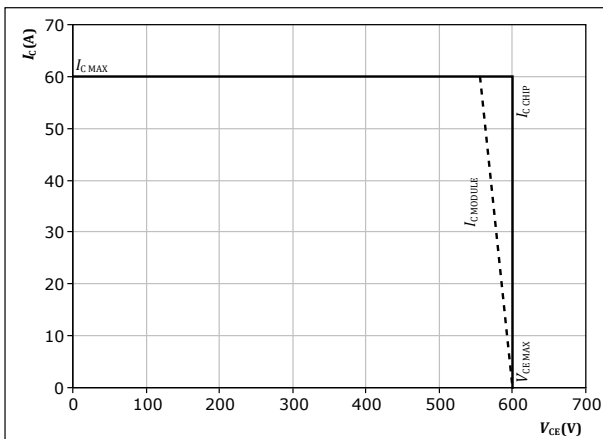


With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 30 \text{ A}$

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 47. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



At $T_j = 150 \text{ } ^\circ\text{C}$
 $R_{goff} = 32 \text{ } \Omega$
 $R_{goff} = 32 \text{ } \Omega$



Switching Definitions

figure 48. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

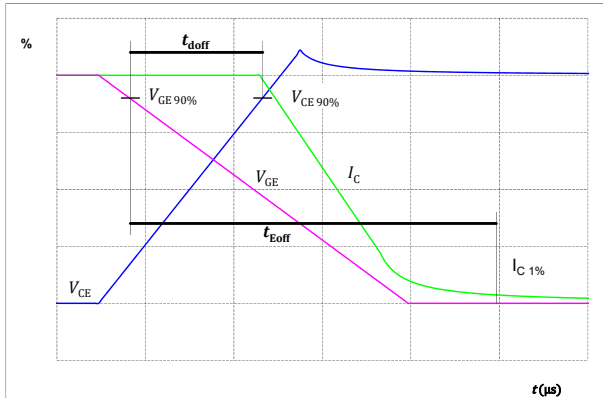


figure 49. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

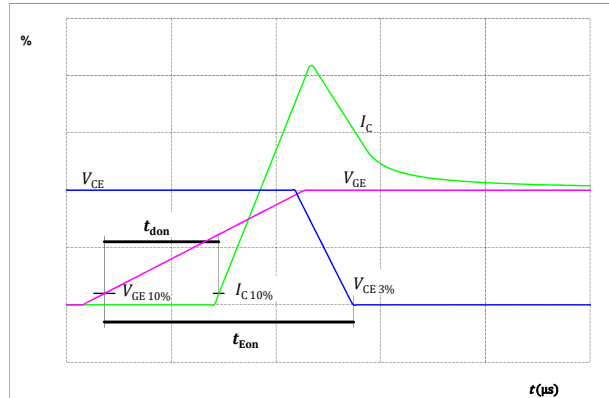


figure 50. IGBT

Turn-off Switching Waveforms & definition of t_f

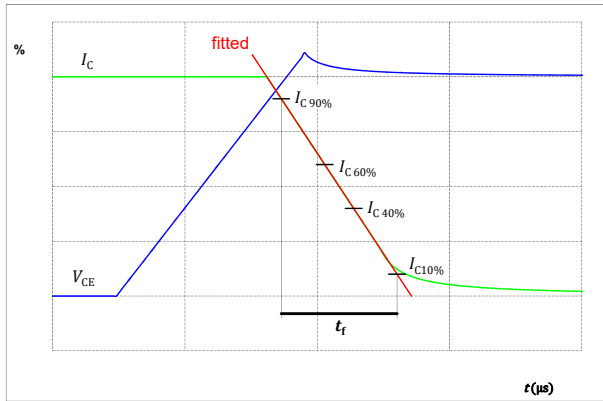
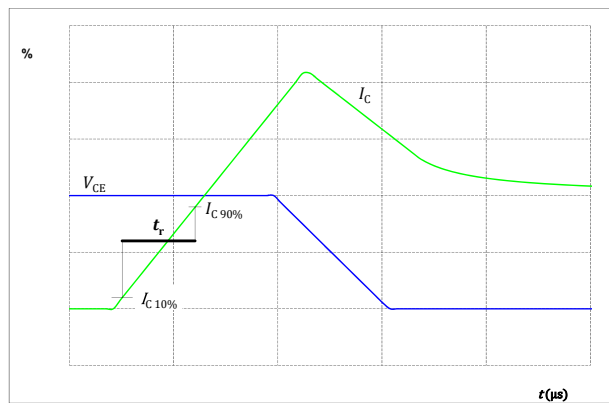


figure 51. IGBT

Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 52. FWD

Turn-off Switching Waveforms & definition of t_{rr}

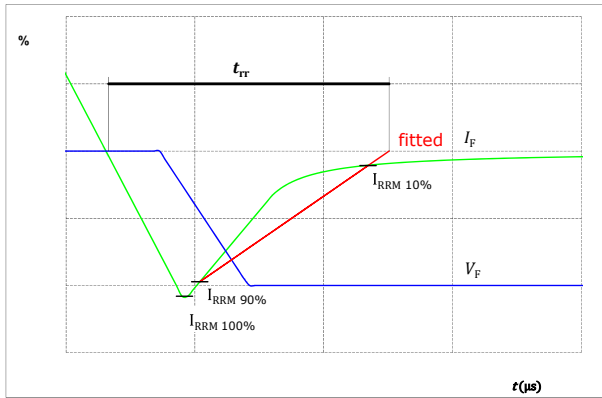
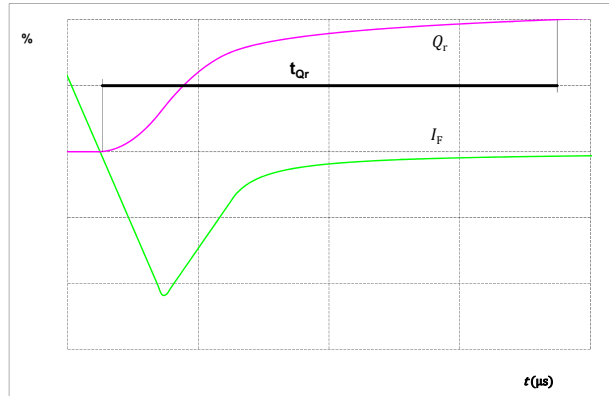


figure 53. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)






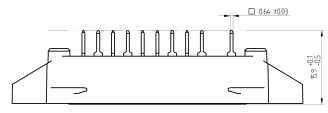
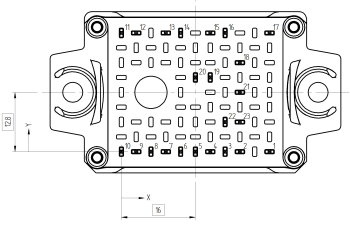
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10-E106PMA030SA-L926A38Z
datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-E106PMA030SA-L926A38Z
With thermal paste	10-E106PMA030SA-L926A38Z-/3/

Marking						
	Text	Name NN-NNNNNNNNNNNNNN- TTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY	

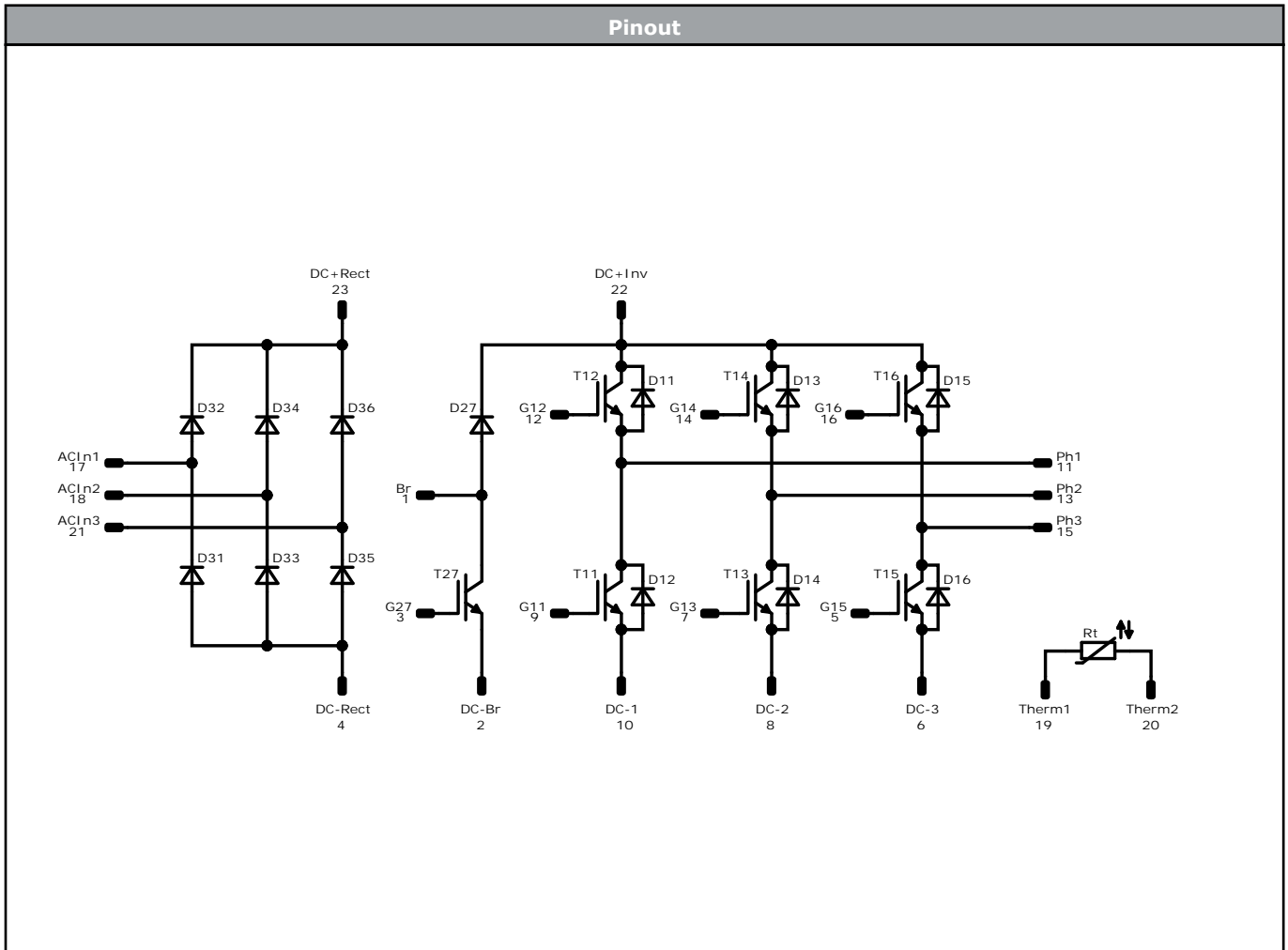
Outline				
Pin table [mm]				
Pin	X	Y	Function	
1	32	0	Br	
2	25,6	0	DC-Br	
3	22,4	0	G27	
4	19,2	0	DC-Rect	
5	16	0	G15	
6	12,8	0	DC-3	
7	9,6	0	G13	
8	6,4	0	DC-2	
9	3,2	0	G11	
10	0	0	DC-1	
11	0	25,6	Ph1	
12	3,2	25,6	G12	
13	9,6	25,6	Ph2	
14	12,8	25,6	G14	
15	19,2	25,6	Ph3	
16	22,4	25,6	G16	
17	32	25,6	ACIn1	
18	25,6	19,2	ACIn2	
19	19,2	16	Therm1	
20	16	16	Therm2	
21	25,6	12,8	ACIn3	
22	22,4	6,4	DC+Inv	
23	25,6	6,4	DC+Rect	

Tolerance of pinposition: ±0,1mm at the end of pins
Dimension of coordinate axis is only of fact without tolerance



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	600 V	30 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	30 A	Inverter Diode	
T27	IGBT	600 V	30 A	Brake Switch	
D27	FWD	600 V	10 A	Brake Diode	
D31, D32, D33, D34, D35, D36	Rectifier	1600 V	28 A	Rectifier Diode	
Rt	NTC			Thermistor	




Vincotech

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> E1 packages see vincotech.com website.

Package data
Package data for <i>flow</i> E1 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-E106PMA030SA-L926A38Z-D1-14	7 Feb. 2021		
10-E106PMA030SA-L926A38Z-D2-14	14 May. 2021	Update characteristics of rectifier diode, leakage current max value 50 -> 100 uA	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.